

## APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

<b>Title of Invention</b>	<b>SYSTEM FOR FABRICATING AN INTEGRATED CIRCUIT PACKAGE ON A PRINTED CIRCUIT BOARD</b>		
<b>Application Type:</b> regular, utility <b>Attorney Docket Number:</b> 27-012			
<b>Correspondence address:</b> <b>Customer Number:</b> 22898 *22898*			
<b>Continuing Data:</b>  This is a Non-Provisional of US application number 60/465,432, filed 2003-04-25.			
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

**Publication Information:****Suggested Figure for Publication – FIG. 1****Suggested Classification –****Suggested Technology Center –****Total Number of Drawing Sheets – 3**

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